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original Documents or copy thereof.

To the Honorable Commissioner of Patents &

-31-08

1. Name of conveying party(ies):
 Takafumi SETO Masaaki TSUJI
 Makoto HIRASAWA Akira OKUYAMA
 Yasufumi HOZUMI Susumu SAITO

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: National Institute of Advanced Industrial Science and Technology
 Internal Address: 3-1, Kasumigaeski, 1-Chome, Chiyoda-Ku, Tokyo, Japan

3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other

Execution Date: January 16, 2008

FISA Corporation
 12-11, Ikegami 7-Chome, Ota-Ku, Tokyo, Japan

City: State: ZIP:

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:
 January 16, 2008

A. Patent Application No.(s)

B. Patent No.(s)

Additional Application numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
 Name: Mark S. Bicks
 Roylance, Abrams, Berdo & Goodman, LLP
 Internal Address:

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41) :..\$40.00

Enclosed
 Authorized to be charged to deposit account

Street Address: 1300 19th Street, NW, Suite 600
 City: Washington State: DC ZIP: 20036

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Mark S. Bicks

Name of Person Signing

Signature

January 31, 2008

Date

Total number of pages including cover sheet, attachments, and document:

4

Mail documents to be recorded with required cover sheet Information to:
 Commissioner of Patents & Trademarks, Box Assignments
 Washington, D.C. 20231

PATENT
REEL: 020506 FRAME: 0066

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ASSIGNMENT

WHEREAS, we,

1. SETO Takafumi residing at c/o National Institute of Advanced Industrial Science and Technology, 2-1, Namiki 1-Chome, Tsukuba-Shi, Ibaraki, Japan
2. HIRASAWA Makoto residing at c/o National Institute of Advanced Industrial Science and Technology, 2-1, Namiki 1-Chome, Tsukuba-Shi, Ibaraki, Japan
3. HOZUMI Yasufumi residing at c/o National Institute of Advanced Industrial Science and Technology, 2-1, Namiki 1-Chome, Tsukuba-Shi, Ibaraki, Japan
4. TSUJI Masaaki residing at c/o National Institute of Advanced Industrial Science and Technology, 2-1, Namiki 1-Chome, Tsukuba-Shi, Ibaraki, Japan
5. OKUYAMA Akira residing at c/o FISA CORPORATION, 12-11, Ikegami 7-Chome, Ota-Ku, Tokyo, Japan
6. SAITO Susumu residing at c/o FISA CORPORATION, 12-11, Ikegami 7-Chome, Ota-Ku, Tokyo, Japan

all citizens of Japan, have made a certain invention entitled
Ion generator and neutralizer

for which we have executed an application for Letters Patent of the United States concurrently herewith; and

WHEREAS, National Institute of Advanced Industrial Science and Technology (hereinafter co-Assignee), 3-1, Kasumigaseki 1-Chome, Chiyoda-Ku, Tokyo, Japan,

and FISA CORPORATION (hereinafter co-Assignee), 12-11, Ikegami 7-Chome, Ota-Ku, Tokyo, Japan

and doing business at the same place is desirous of acquiring the entire right, title and interest in and to the aforementioned invention and the aforementioned application and any and all Letters Patent to be obtained on said invention and/or applications;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to Assignors by said Assignee, the receipt and sufficiency of which is hereby acknowledged, said Assignors, by these presents do hereby sell, assign, set over and transfer unto said Assignee, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States; and in, to and under the aforesaid United States application and any divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filed on said invention in the United States; and any Letters Patent of the United States issued or granted on said invention and/or said application;

AND WE HEREBY authorize and request the U. S. Patent and Trademark Office or other issuing authority to issue any and all patents on said invention and/or said application to said Assignee as sole assignee;

AND WE HEREBY covenant that we have the full right to convey the entire right, title and interest herein assigned and that we have not executed and will not execute any assignment or other instrument in conflict herewith;

AND WE WHEREBY further covenant and agree to communication to said Assignee, or its legal representatives, successors or assigns, any facts relating to said invention, including evidence for interference or other proceedings, whenever requested, and testify in any interference or in any other legal proceeding, when requested; and to execute and deliver or request all lawful papers required to make any of the foregoing provisions effective; and to perform the aforesaid communicating, executing and delivering, without any payment except expenses to perform the aforesaid testifying for reasonable compensation; and generally to do everything possible to aid said Assignee, its successors, legal representatives or assigns to obtain and enforce proper patent protection on and for said invention and likewise we make these provisions binding upon our heirs, legal representatives and/or administrators.

IN WITNESS WHEREOF, we have executed this Assignment as of
the 16th day of Jan. , 2008 set forth hereinafter.

(Signature) Takafumi Seto
Assignor: SETO Takafumi

(Signature) M. Hirasawa
Assignor: HIRASAWA Makoto

(Signature) Y. Hozumi
Assignor: HOZUMI Yasufumi

(Signature) M. Tsuji
Assignor: TSUJI Masaaki

(Signature) A. Okuyama
Assignor: OKUYAMA Akira

(Signature) S. Saito
Assignor: SAITO Susumu